

Infonote

AO-IN-2025-056-I

New PFAs-free Die Attach Epoxy Glue for:

TMD27621

TMD27623

TMD27721

TMD37024VC

02.10.2025

Dear Customer,

please take note of this **Infonote**.
This customer notification is for information only and does not require customer approval.

Objective: New PFAs-free Die Attach Epoxy Glue for TMD27621, TMD27623, TMD27721 and TMD37024VC.

Affected products:	SAP MPN	Description	Ordering Code
	300170025	TMD26721 MOD8 LF T&RDP	Q65114A3319
	300170011	TMD26723 MOD8 LF T&RDP	Q65114A0930
	300170021	TMD27721 MOD8 LF T&RDP	Q65114A3420
	504270040	TMD37024VC OLGA8 LF UT	

Reason for change: The current die attach glue supplier will stop producing epoxy that contains PFAs (Polyfluoroalkyl substance) material by end of 2025. Thus, a new epoxy that is PFAs-free will be qualified.

	<u>Current status</u>	<u>New status</u>
Description of change:	The current die attach epoxy glue contains PFAs material.	A new PFAs-free glue epoxy will be qualified and will replace the current die attach epoxy glue.

Time schedule: December 2025

Assessment: Low reliability risk. The change does not have impact to form, fit and function of the products.